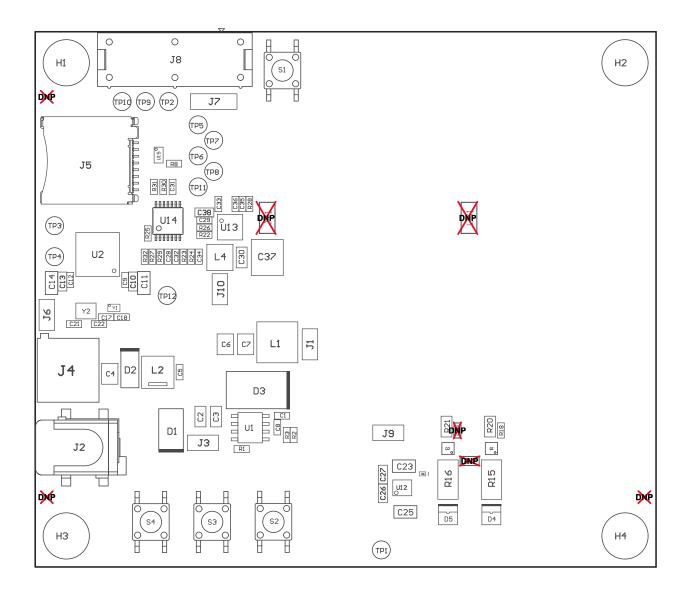
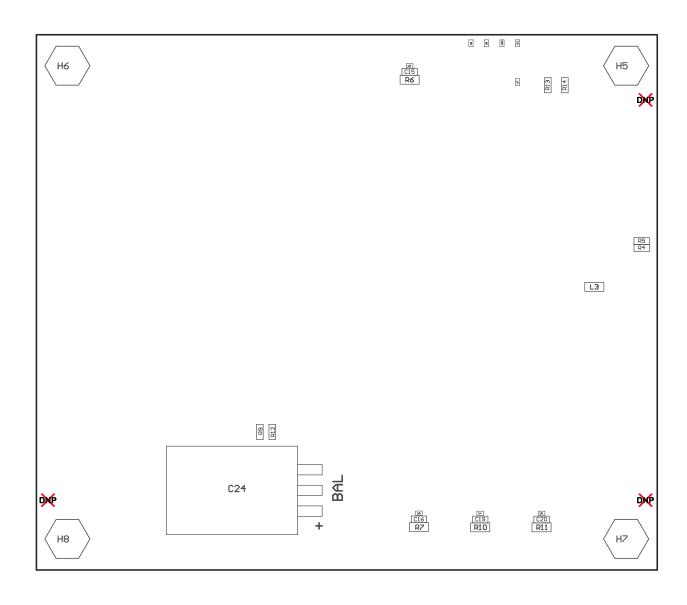
- ZZ1 These assemblies are ESD sensitive, ESD precautions shall be observed.
- ZZ2 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- ZZ3 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
- ZZ4 Jumpers should be placed on J1, J3, J6, J7 (pins 2-3), J9, and J10.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV:	Not In VersionControl	
	TID #: TIDA-00376				
PLOT NAME = Top Assembly Drawing	GENERATED : 6	/4/2015 12:50:00	3 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: ISE4028	REV: E1	SUN REV	: Not In VersionControl		
	TID #: TIDA-00376					
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/4/20	015 12:50:05	PM	TEXAS INSTRUMENTS		

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